

FIG. 2

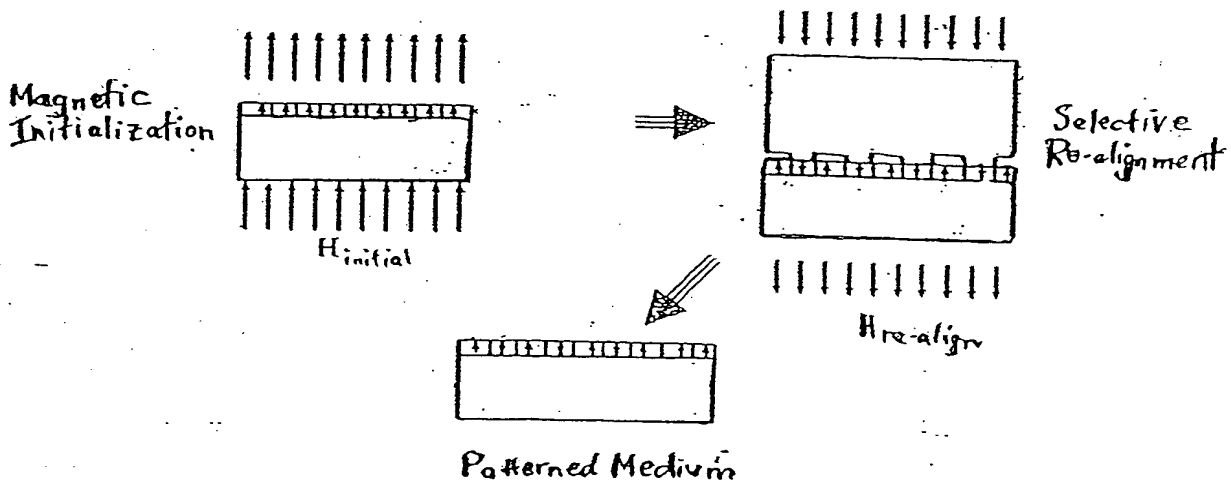
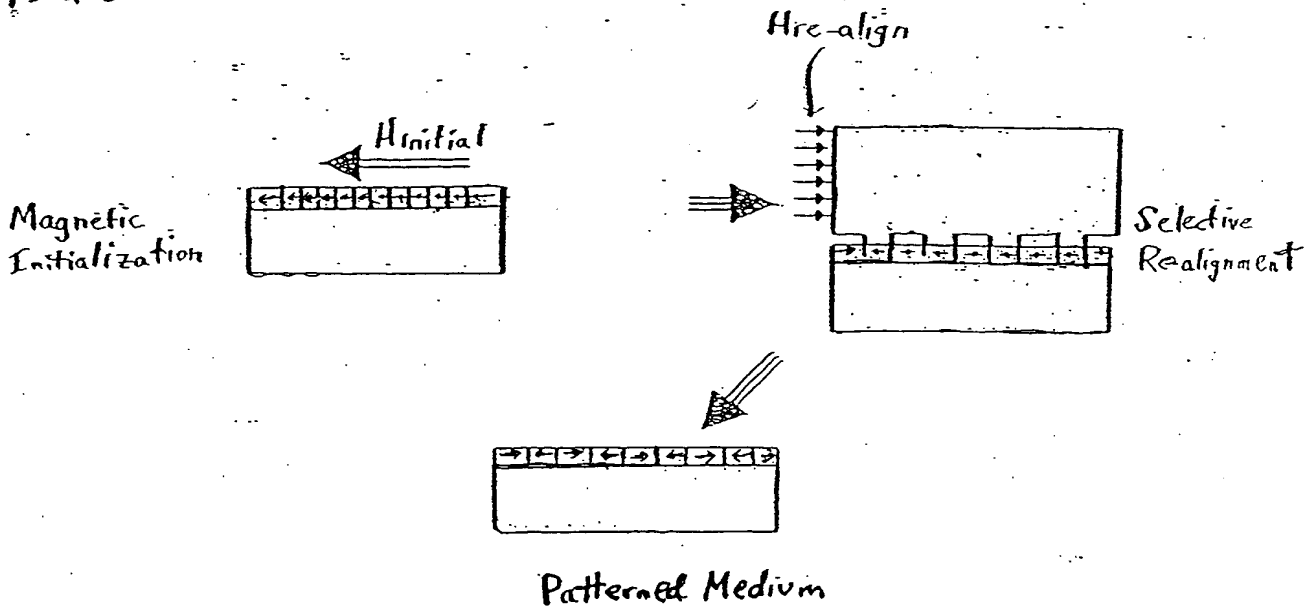


FIG. 3



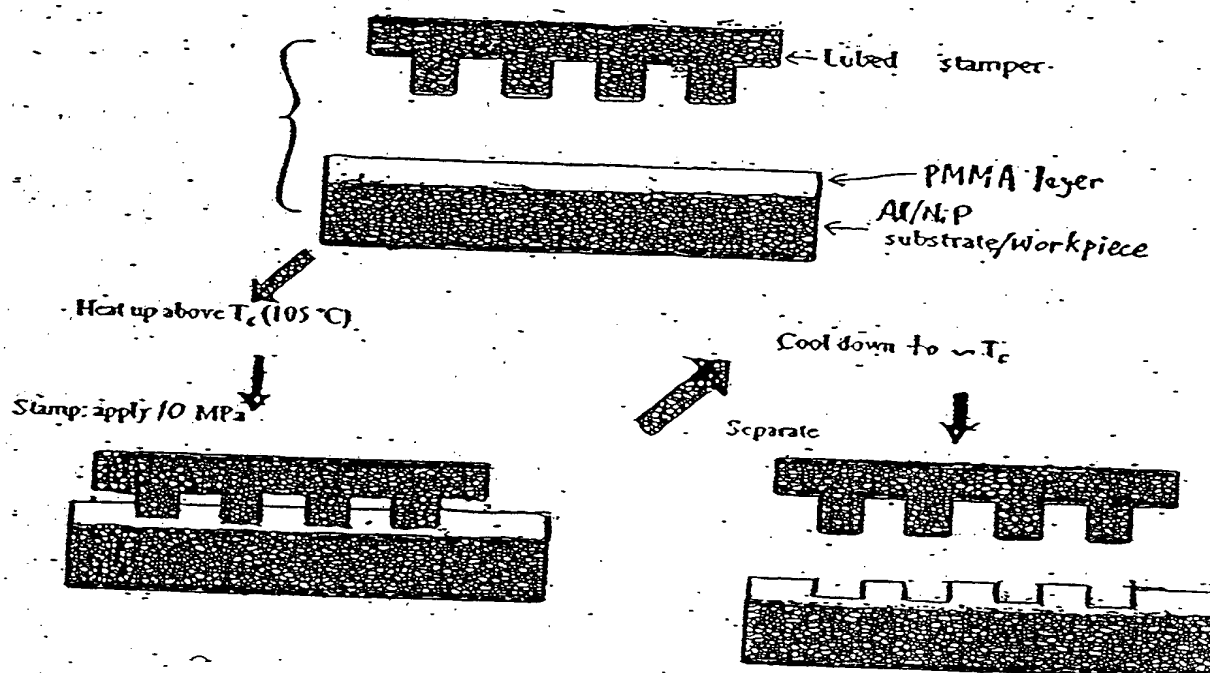


FIG. 5

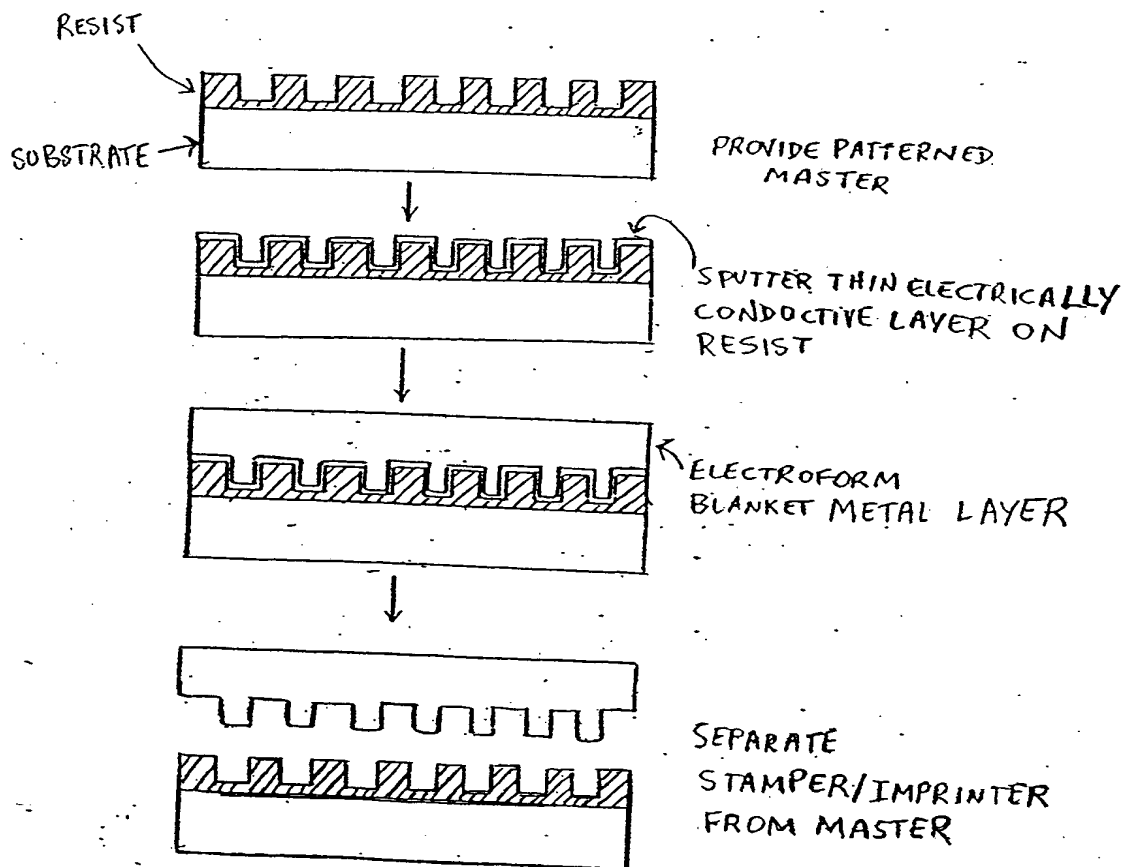


FIG. 6

FIG. 7(A)

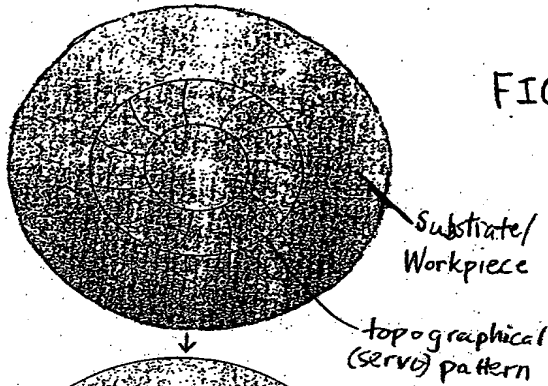
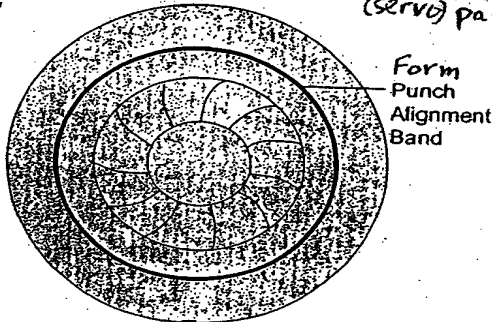


FIG. 8

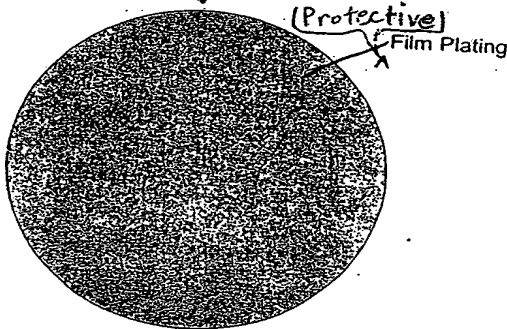
801
Provide substrate/workpiece
with topographical (servo)
pattern formed in central
area of surface

FIG. 7(B)



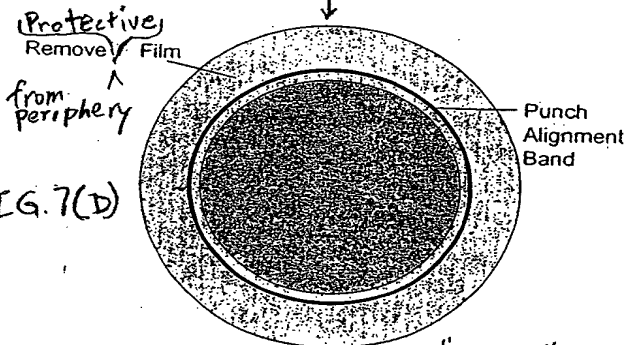
802
Form alignment mark (band)
surrounding pattern
periphery
form layer of release
material on surface

FIG. 7(C)



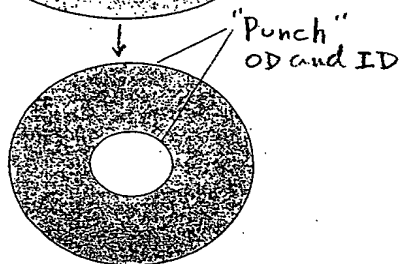
803
Form protective film
on surface of
substrate/workpiece

FIG. 7(D)



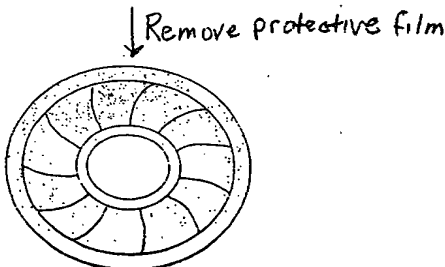
804
Remove peripheral portion
of protective film to
expose alignment band

FIG. 7(E)



805
"Punch" substrate/workpiece
to form annular disk with
Inner Diameter (ID) and
Outer Diameter (OD)

FIG. 7(F)



806
Remove protective film
to expose topographical
(servo) pattern prior to use